Assurance Continuity Maintenance Report

BSI-DSZ-CC-0399-2007-MA-02

Infineon Smart Card IC (Security Controller) SLE66CLX800PE / m1581-e12, SLE66CLX800PEM / m1580-e12, SLE66CLX800PES / m1582-e12, SLE66CLX360PE / m1587-e12, SLE66CLX360PEM / m1588-e12 and SLE66CLX360PES / m1589-e12 with specific IC Dedicated Software

from

Infineon Technologies AG

Common Criteria Recognition Arrangement
for components up to EAL4

The IT product identified in this report was assessed according to the *Assurance Continuity: CCRA Requirements,* version 1.0, February 2004 and the developers Impact Analysis Report (IAR). The baseline for this assessment was the Certification Report, the Security Target and the Evaluation Technical Report of the product certified by the Federal Office for Information Security (BSI) under BSI-DSZ-CC-0399-2007.

The change to the certified product is at the level of the included development, production and delivery sites, a change that has no effect on assurance. No changes of hardware or IC dedicated software are applied, the TOE version did not change.

Consideration of the nature of the change leads to the conclusion that it is classified as a minor change and that certificate maintenance is the correct path to continuity of assurance.

Therefore, the assurance as outlined in the Certification Report BSI-DSZ-CC-0399-2007 is maintained for this version of the product. Details can be found on the following pages.

This report is an addendum to the Certification Report BSI-DSZ-CC-0399-2007.

Bonn, 29 January 2009

Assessment

The IT product identified in this report was assessed according to the *Assurance Continuity: CCRA Requirements* [1] and the Impact Analysis Report (IAR) [2]. The baseline for this assessment was the Certification Report of the certified product (Target of Evaluation, TOE) [3], the Security Target [4] and the Evaluation Technical Report as outlined in [3].

The vendor for the Infineon Smart Card IC (Security Controller) SLE66CLX800PE / m1581-e12, SLE66CLX800PEM / m1580-e12, SLE66CLX800PES / m1582-e12, SLE66CLX360PE / m1587-e12, SLE66CLX360PEM / m1588-e12 and SLE66CLX360PES / m1589-e12 with specific IC Dedicated Software, Infineon Technologies AG, submitted an IAR [2] to the BSI for approval. The IAR is intended to satisfy the requirements outlined in the document *Assurance Continuity: CCRA Requirements* [1]. In accordance with those requirements, the IAR describes (i) the changes made to the certified TOE, (ii) the evidence updated as a result of the changes and (iii) the security impact of the changes.

The Common Criteria assurance requirements

- ACM – Configuration management (i.e. ACM_AUT.1, ACM_CAP.4, ACM_SCP.3),
- ADO – Delivery and operation (i.e. ADO_DEL.2, ADO_IGS.1) and
- ALC – Life cycle support (i.e. ALC_DVS.2, ALC_LCD.2, ALC_TAT.2),

are fulfilled for the audited sites of the TOE listed completely below:

Site	Address	Function
Altis	Altis Semiconductors S.N.C. Boulevard John Kennedy 224 91105 Corbeil Essonnes France	Production
Altis-Toppan	Toppan Photomask, Inc. European Technology Center Boulevard John Kennedy 224 91105 Corbeil Essonnes Cedex, France	Mask Center
Amkor	Amkor Technology Philippines Km. 22 East Service Rd. South Superhighway Muntinlupa City 1702 Philipines Amkor Technology Philippines 119 North Science Avenue Laguna Technopark, Binan Laguna 4024, Philipines	Module Mounting
Augsburg	Infineon Technologies AG Secure Mobile Solutions Alter Postweg 101 86159 Augsburg, Germany	Development

Site	Address	Function
Bangkok	Smartrac Technology, 142 Moo 1 Hi-Tech industrial Estate, Ban Laean, Bang, Pa-In Phra na korn Si Ayatthaya, 13160 Thailand	Inlay Antenna Mounting
Bucharest	Infineon Technology AG Bd. Dimitrie Pompeiu 6, Sector 2 020335 Bucharest, Romania	Development
Dresden-Toppan	Toppan Photomask, Inc Rähnitzer Allee 9 01109 Dresden, Germany	Mask Center
Erfurt	Assa Abloy Identification Technologies GmbH (former Sokymat GmbH) In den Weiden 4b, 99099 Erfurt	Module Mounting with Inlay Antenna Mounting
Graz / Villach / Klagenfurt	Infineon Technologies Austria AG Development Center Graz Babenbergerstr. 10 8020 Graz, Austria Infineon Technologies Austria AG Siemensstr. 2 9500 Villach, Austria Infineon Technologies Austria AG Lakeside B05 9020 Klagenfurt, Austria	Development
Großostheim	Infineon Technology AG, DCE, Kühne & Nagel Stockstädter Strasse 10 - Building 8A 63762 Großostheim, Germany	Distribution Center
Hayward	Kuehne & Nagel 30805 Santana Street Hayward, CA 94544 U.S.A.	Distribution Center
Lustenau	New Logic Technologies AG, - A Wipro Company, Millenium Park 6, 6890 Lustenau, Austria	Development
Munich	Infineon Technologies AG Am Campeon 1-12 85579 Neubiberg, Germany Infineon Technologies AG Otto-Hahn-Ring 6 81739 München (Perlach), Germany	Development
Regensburg-West	Infineon Technologies AG Wernerwerkstraße 2 93049 Regensburg, Germany Smartrac Technology GmbH, Wernerwerkstraße 2 93049 Regensburg, Germany	Module Mounting Inlay Antenna Mounting, Distribution Center
Singapore	DHL Exel Singapore Pte Ltd Richland Business Center 11 Bedok North Ave 4 Singapore	Distribution Center
Singapore Kallang	Infineon Technologies AG 168 Kallang Way Singapore 349253	Module Mounting

Site	Address	Function
Tokyo	Kintetsu World Express, Inc. Tokyo Import Logistics Center Narita Terminal Tokyo, Japan	Distribution Center
Wuxi	Infineon Technologies (Wuxi) Co. Ltd. No. 118, Xing Chuang San Lu Wuxi-Singapore Industrial Park Wuxi 214028, Jiangsu, P.R. China	Module Mounting, Distribution Center

The change to the TOE is at the level of the evaluated and included sites. The product functionality did not change. Furthermore, the changes are not significant from the standpoint of security.

Conclusion

The changes to the TOE are at the level of the included sites and modification of the isolation layer, those changes that have no effect on assurance. Examination of the evidence indicates that the changes required are limited to inclusion of the additional development and production sites as listed above. The Security Target [4] is still valid for the changed TOE. Consideration of the nature of the change leads to the conclusion that it is classified as a minor change and that certificate maintenance is the correct path to continuity of assurance.

Therefore, BSI agrees that the assurance as outlined in the Certification Report [3] is maintained for the product and the product versions SLE66CLX800PE / m1581-e12, SLE66CLX800PEM / m1580-e12, SLE66CLX800PES / m1582-e12, SLE66CLX360PE / m1587-e12, SLE66CLX360PEM / m1588-e12 and SLE66CLX360PES / m1589-e12 with specific IC Dedicated Software for that the certificate BSI-DSZ-CC-0399-2007 also applies. This report is an addendum to the Certification Report [3].

References

[1] Common Criteria document CCIMB-2004-02-009 "Assuarance Continuity: CCRA Requirements", version 1.0, February 2004

[2] IAR BSI-DSZ-0399-2007-MA-02, Infineon Smart Card IC (Security Controller) SLE66CLX800PE M1581-e12, SLE66CLX800PEM M1580-e12, SLE66CLX800PES M1582-e12, SLE66CLX360PE M1587-e12, SLE66CLX360PEM M1588-e12, SLE66CLX360PES M1589-e12 with specific IC Dedicated Software, Version 1.1, 21.01.2009, Infineon Technologies AG (confidential document)

[3] Certification Report BSI-DSZ-CC-0399-2007 for Infineon Smart Card IC (Security Controller) SLE66CLX800PE / m1581-e12, SLE66CLX800PEM / m1580-e12, SLE66CLX800PES / m1582-e12, SLE66CLX360PE / m1587-e12, SLE66CLX360PEM / m1588-e12 and SLE66CLX360PES / m1589-e12 with specific IC Dedicated Software, Bundesamt für Sicherheit in der Informationstechnik, 2007-01-29

[4] Infineon Technologies AG, Security and Chipcard ICs, Security Target, SLE66CLX800PE / m1581-e12, SLE66CLX800PEM / m1580-e12, SLE66CLX800PES / m1582-e12, SLE66CLX360PE / m1587-e12, SLE66CLX360PEM / m1588-e12, SLE66CLX360PES / m1589-e12, 11. December 2006, Version 1.3